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September 2015

FDMD85100 Dual N-Channel PowerTrench[®] MOSFET

FDMD85100

Dual N-Channel PowerTrench[®] MOSFET Q1: 100 V, 48A, 9.9 m Ω Q2: 100 V, 48A, 9.9 m Ω

Features

Q1: N-Channel

- Max $r_{DS(on)}$ = 9.9 m Ω at V_{GS} = 10 V, I_D = 10.4 A
- Max r_{DS(on)} = 16.4 mΩ at V_{GS} = 6 V, I_D = 8 A

Q2: N-Channel

- Max r_{DS(on)} = 9.9 mΩ at V_{GS} = 10 V, I_D = 10.4 A
- Max $r_{DS(on)}$ = 16.4 m Ω at V_{GS} = 6 V, I_D = 8 A
- Ideal for flexible layout in primary side of bridge topology
- Termination is Lead-free and RoHS Compliant
- 100% UIL tested
- Kelvin High Side MOSFET drive pin-out capability

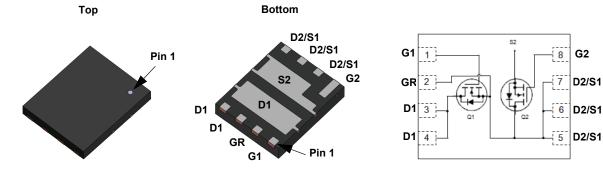
South P HAA

General Description

This device includes two 100V N-Channel MOSFETs in a dual Power (5 mm X 6 mm) package. HS source and LS Drain internally connected for half/full bridge, low source inductance package, low $r_{DS(on)}/Qg$ FOM silicon.

Applications

- Synchronous Buck : Primary Switch of Half / Full Bridge Bonverter for Telecom
- Motor Bridge : Primary Switch of Half / Full Bridge Converter for BLDC Motor
- MV POL : 48V Synchronous Buck Switch
- Half/Full Bridge Secondary Synchronous Rectification



Power 5 x 6

MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted.

| Symbol | Parame | ter | | Q1 | Q2 | Units |
|-----------------------------------|--|-------------------------|----------|--------------------|--------------------|-------|
| V _{DS} | Drain to Source Voltage | | | 100 | 100 | V |
| V _{GS} | Gate to Source Voltage | | | ±20 | ±20 | V |
| | Drain Current -Continuous | T _C = 25 °C | (Note 5) | 48 | 48 | |
| | -Continuous | T _C = 100 °C | (Note 5) | 30 | 30 | • |
| D | Drain Current -Continuous | T _A = 25 °C | | 10.4 ^{1a} | 10.4 ^{1b} | A |
| | -Pulsed | | (Note 4) | 261 | 261 | |
| E _{AS} | Single Pulse Avalanche Energy | | (Note 3) | 294 | 294 | mJ |
| P _D | Power Dissipation | T _C = 25 °C | | 50 | 50 | w |
| | Power Dissipation | T _A = 25 °C | | 2.2 ^{1a} | 2.2 ^{1b} | vv |
| T _J , T _{STG} | Operating and Storage Junction Temperature Range | | -55 to | +150 | °C | |

Thermal Characteristics

| $R_{	ext{	heta}JC}$ | Thermal Resistance, Junction-to-Case | 2.5 | 2.5 | °C/W |
|---------------------|---|------------------|------------------|------|
| $R_{	hetaJA}$ | Thermal Resistance, Junction-to-Ambient | 55 ^{1a} | 55 ^{1b} | C/VV |

Package Marking and Ordering Information

| Device Marking | Device | Package | Reel Size | Tape Width | Quantity |
|----------------|-----------|-------------|-----------|------------|------------|
| FDMD85100 | FDMD85100 | Power 5 x 6 | 13 " | 12 mm | 3000 units |

| FDMD85100 Dual N |
|--------------------------|
| Dual I |
| N-Channel |
| PowerTrench [®] |
| MOSFET |

| Symbol | Parameter | Test Conditions | Туре | Min. | Тур. | Max. | Units |
|--|---|--|----------|------------|--------------|--------------|-------|
| Off Cha | racteristics | | | | | | |
| BV _{DSS} | Drain to Source Breakdown Voltage | I_{D} = 250 μ A, V _{GS} = 0 V | Q1 Q2 | 100 100 | | | V |
| $\frac{\Delta BV_{DSS}}{\Delta T_{J}}$ | Breakdown Voltage Temperature Coefficient | I_D = 250 µA, referenced to 25 °C | Q1 Q2 | | 72 70 | | mV/°C |
| I _{DSS} | Zero Gate Voltage Drain Current | V _{DS} = 80 V, V _{GS} = 0 V | Q1 Q2 | | | 1 1 | μA |
| I _{GSS} | Gate to Source Leakage Current | V _{GS} = ±20 V, V _{DS} = 0 V | Q1 Q2 | | | ±100 ±100 | nA |
| On Char | acteristics | | | | | | |
| V _{GS(th)} | Gate to Source Threshold Voltage | $V_{GS} = V_{DS}, I_D = 250 \ \mu A$ | Q1 Q2 | 2.0 2.0 | 3.1 3.0 | 4.0 4.0 | V |
| $\frac{\Delta V_{GS(th)}}{\Delta T_J}$ | Gate to Source Threshold Voltage Temperature Coefficient | I_D = 250 µA, referenced to 25 °C | Q1 Q2 | | -11 -10 | | mV/°C |
| | | $V_{GS} = 10 \text{ V}, \text{ I}_{D} = 10.4 \text{ A}$ | Q1 | | 7.8 12.6 | 9.9 16.4 | |
| r | Static Drain to Source On Resistance | $V_{GS} = 6 V$, $I_D = 8 A$ $V_{GS} = 10 V$, $I_D = 10.4 A$, $T_J = 125 °C$ | QI | | 12.6 | 18.7 | mΩ |
| r _{DS(on)} | | $V_{GS} = 10 \text{ V}, I_D = 10.4 \text{ A}$ $V_{GS} = 6 \text{ V}, I_D = 8 \text{ A}$ | Q2 | | 7.8 12.9 | 9.9 16.4 | |
| | | $V_{GS} = 10 \text{ V}, I_D = 10.4 \text{ A}, T_J = 125 ^{\circ}\text{C}$ | QZ | | 14.6 | 18.6 | |
| 9 _{FS} | Forward Transconductance | V _{DD} = 5 V, I _D = 10.4 A | Q1 Q2 | | 27 26 | | S |
| Dynami | c Characteristics | | | | | | |
| C _{iss} | Input Capacitance | | Q1 Q2 | | 1590 1485 | 2230 2080 | pF |

Electrical Characteristics T_J = 25 °C unless otherwise noted.

| C _{iss} | Input Capacitance | | Q1 Q2 | | 1590 1485 | 2230 2080 | pF |
|------------------|------------------------------|--|----------|------------|--------------|--------------|----|
| C _{oss} | Output Capacitance | V _{DS} = 50 V, V _{GS} = 0 V f = 1 MHz | Q1 Q2 | | 334 337 | 470 475 | pF |
| C _{rss} | Reverse Transfer Capacitance | | Q1 Q2 | | 13 13 | 23 23 | pF |
| R _g | Gate Resistance | | Q1 Q2 | 0.1 0.1 | 1.5 1.3 | 3.8 3.3 | Ω |

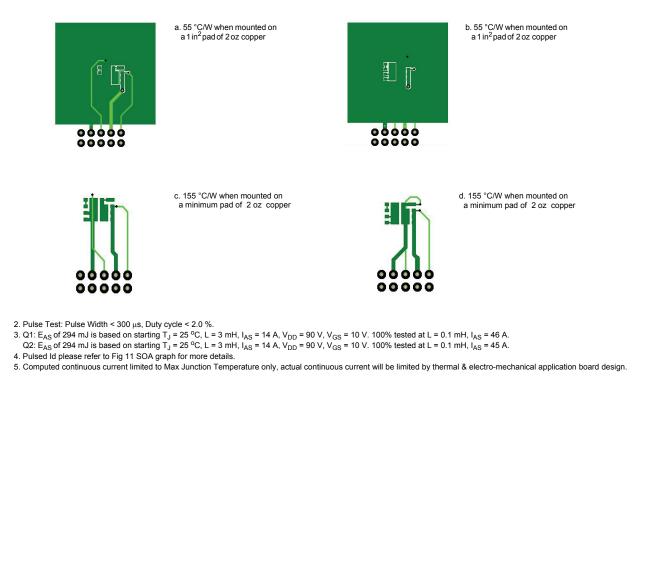
Switching Characteristics

| t _{d(on)} | Turn-On Delay Time | | | Q1 Q2 | 14 12.5 | 25 23 | ns |
|---------------------|-------------------------------|---|--|----------|------------|----------|----|
| t _r | Rise Time | | | Q1 Q2 | 5 | 10 | ns |
| ' | | V _{DD} = 50 V, I _D = 10 | | | 5.6 | 11 | |
| | Turn Off Dalay Time | V _{GS} = 10 V, R _{GEN} : | V _{GS} = 10 V, R _{GEN} = 6 Ω | Q1 | 19 | 30 | |
| t _{d(off)} | Turn-Off Delay Time | | | | 18 | 32 | ns |
| | E | | | Q1 | 4.2 | 10 | |
| t _f | Fall Time | | | Q2 | 4.4 | 10 | ns |
| 0 | Tatal Cata Charge | $\gamma = 0 \gamma t_{0} 10 \gamma t_{0}$ | | Q1 | 22 | 31 | nC |
| Q _{g(TOT)} | Total Gate Charge | V_{GS} = 0 V to 10 V | | Q2 | 21 | 29 | nc |
| <u> </u> | Tatal Cata Channa | | _ | Q1 | 14 | 20 | |
| Q _{g(TOT)} | Total Gate Charge | V_{GS} = 0 V to 6 V | | Q2 | 13.5 | 19 | nC |
| 0 | O sta ta O sugar Oli sugar | | []] V _{DD} = 50 V, ID =10.4 A | Q1 | 7.3 | | |
| Q _{gs} | Gate to Source Charge | | -10.4 A | Q2 | 6.8 | | nC |
| 0 | Cata ta Drain "Millar" Charge | | | Q1 | 4.3 | | ~0 |
| Q _{gd} | Gate to Drain "Miller" Charge | | | Q2 | 4.4 | | nC |

| Symbol | Parameter | Test Conditions | | Туре | Min | Тур | Max | Units |
|-----------------|---|---|----------|------|-----|-----|-----|-------|
| Drain-S | ource Diode Characteristics | | | | | | | |
| V _{SD} | Source to Drain Diode Forward Voltage | $V_{-2} = 0 V_{-1} = 10.4 $ | (Note 2) | Q1 | | 0.8 | 1.3 | V |
| vsD | Source to Drain Diode i of ward voltage | VGS - 0 V, IS - 10.4 A | | Q2 | | 0.8 | 1.3 | v |
| V | Source to Drain Diode Forward Voltage | $V_{\rm ex} = 0 V_{\rm ex} = 2 \Lambda$ | (Note 2) | Q1 | | 0.7 | 1.2 | V |
| V _{SD} | Source to Drain Diode I of ward voltage | V _{GS} = 0 V, I _S = 2 A | | Q2 | | 0.7 | 1.2 | |
| • | Reverse Recovery Time | | | Q1 | | 48 | 77 | ns |
| Lrr | | 5 | | Q2 | | 47 | 75 | 115 |
| 0 | Reverse Recovery Charge | I _F = 10.4 A, di/dt = 100 A/μs | | Q1 | | 53 | 85 | nC |
| Q _{rr} | Reverse Recovery Charge | | | Q2 | | 51 | 82 | |

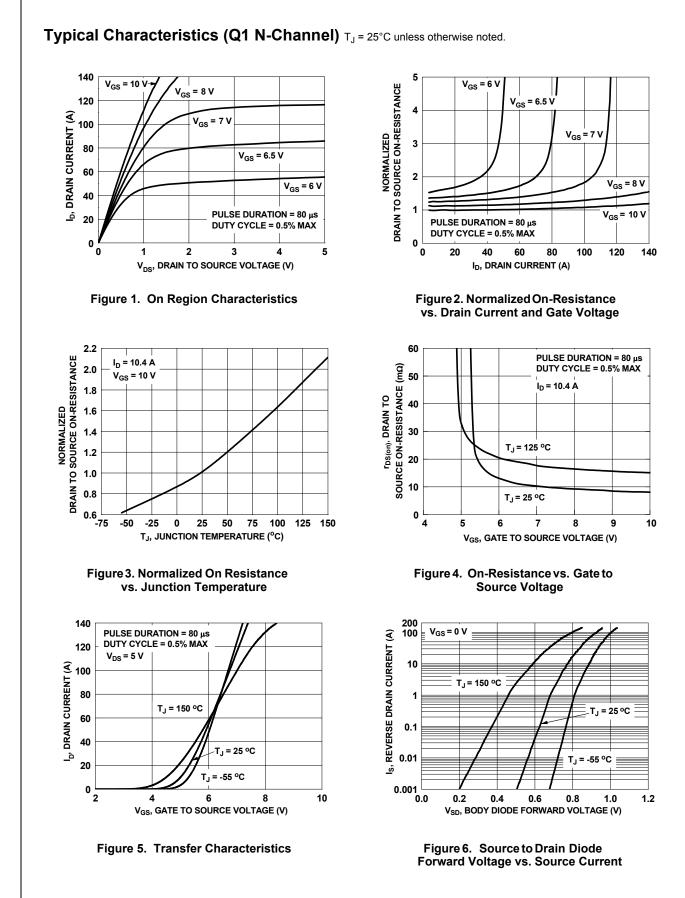
NOTES:

1. R_{8JA} is determined with the device mounted on a 1 in² pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R_{8CA} is determined by the user's board design.

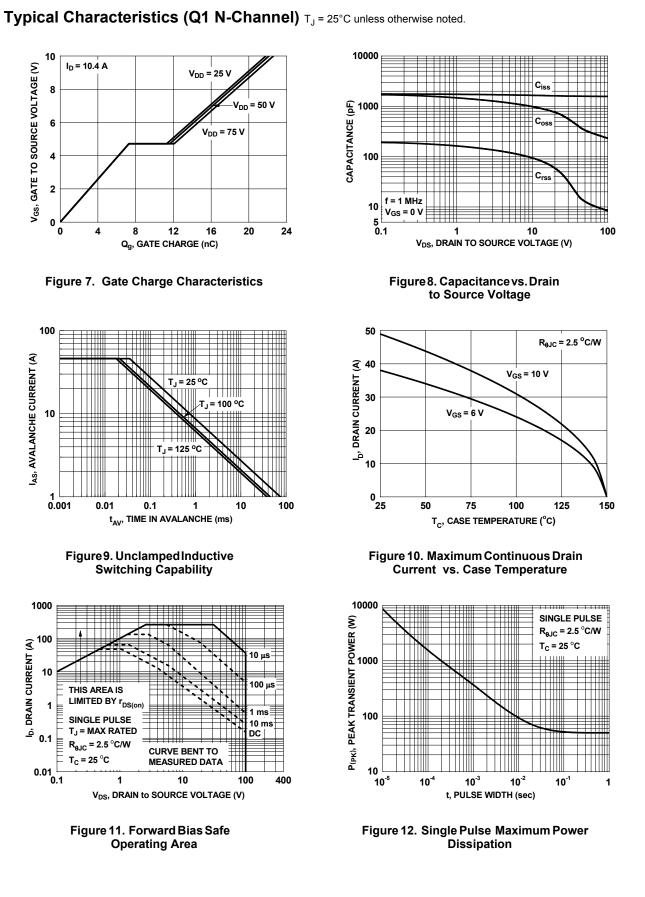


FDMD85100 Dual N-Channel PowerTrench[®] MOSFET

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©2015 Fairchild Semiconductor Corporation FDMD85100 Rev.1.2



FDMD85100 Dual N-Channel PowerTrench[®] MOSFET

10

8

6

4

2

0

100

AVALANCHE CURRENT (A)

AS,

1000

₀, DRAIN CURRENT (A) 1 001

ف

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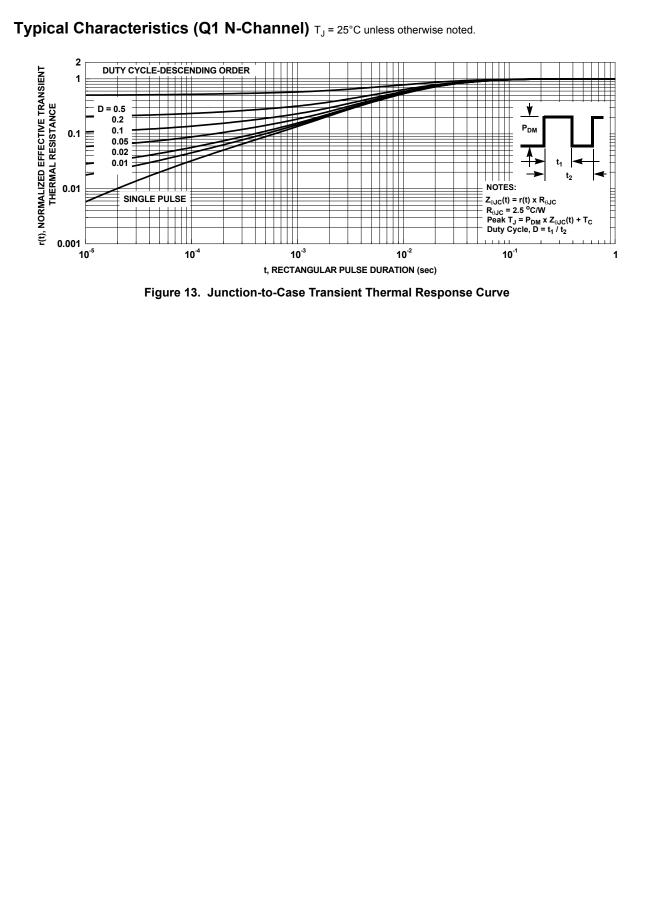
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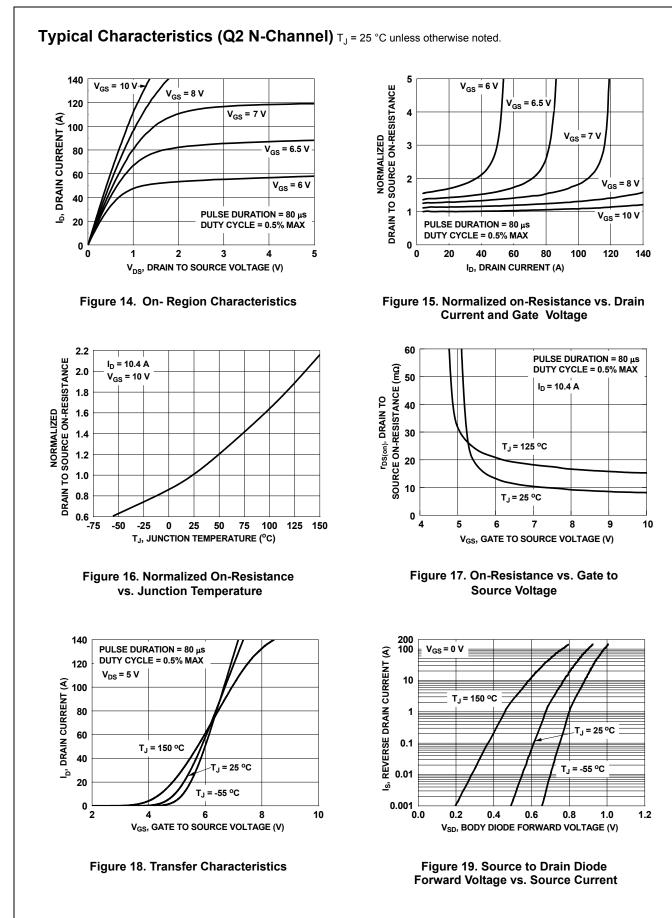
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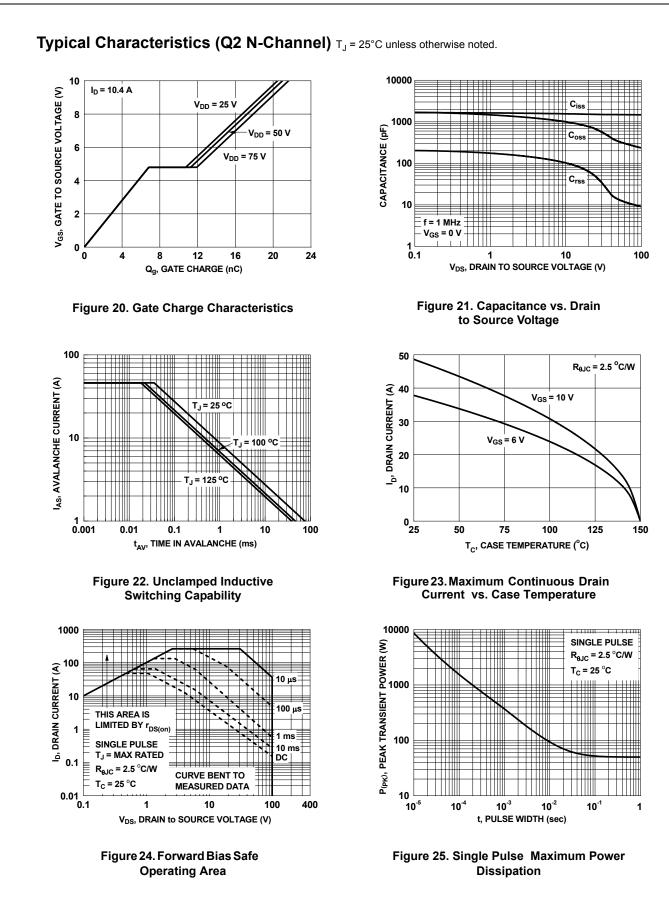
V_{GS}, GATE TO SOURCE VOLTAGE (V)



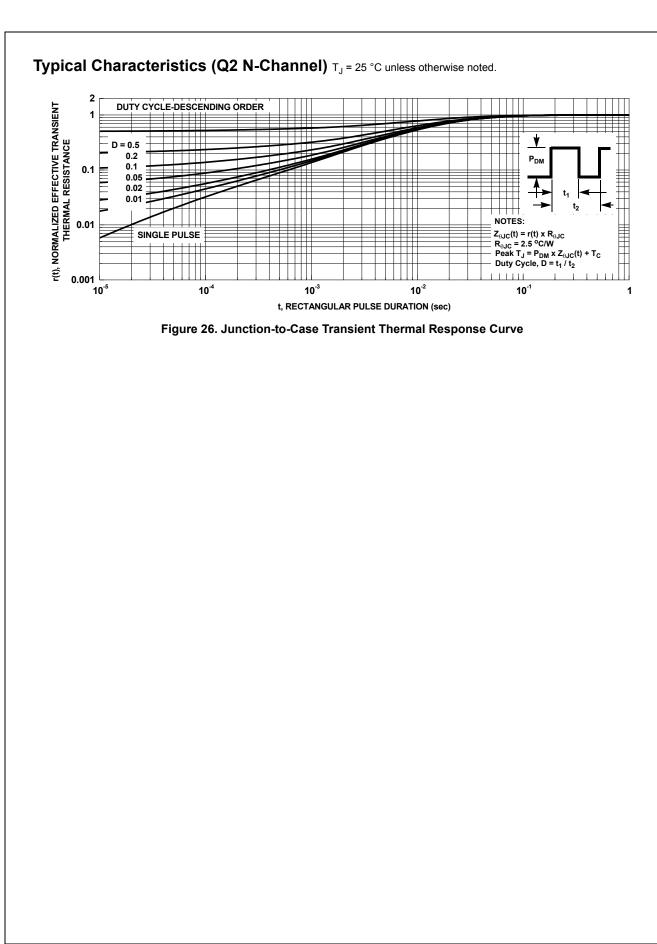


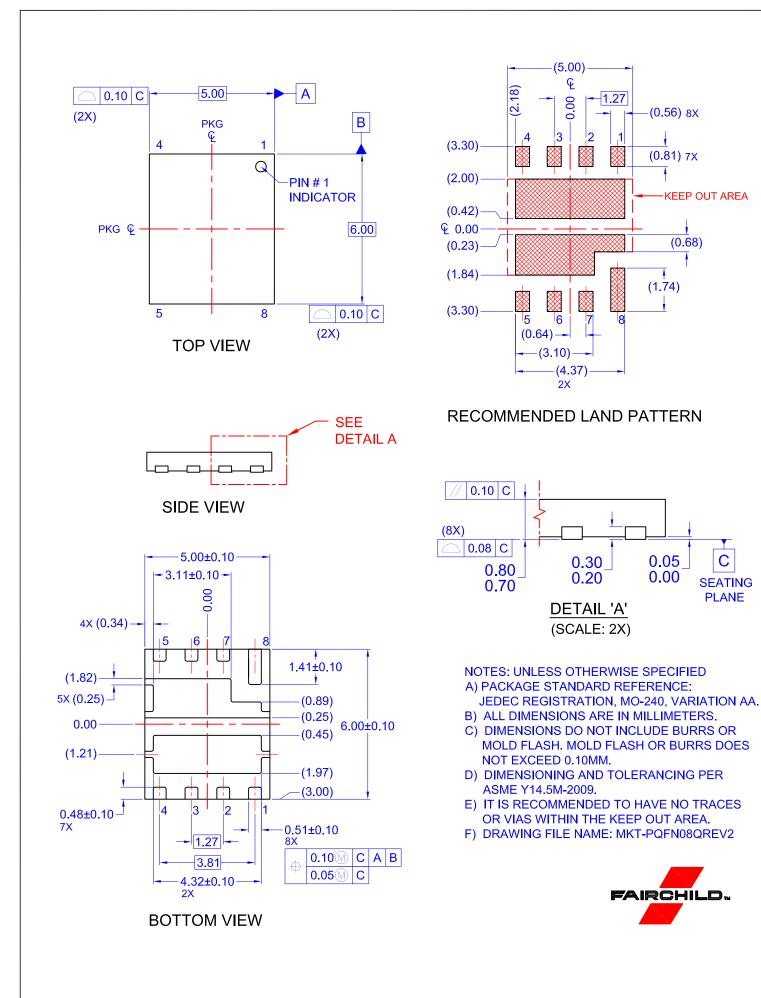
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